

BLE pairing using NFC on KW41 with NTAG I2C plus Software License and Distribution Agreement

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10. **Governing Law; Jurisdiction.** This Agreement shall be governed by and construed in accordance with the laws of The Netherlands without regard to any principle of conflicts of law. Any dispute arising hereunder shall be resolved in the competent courts in Amsterdam, The Netherlands, and the Parties hereby agree that venue and jurisdiction for any related proceedings arising hereunder shall lie exclusively with such courts; provided, however, that each Party may enforce its and its Affiliates' intellectual property rights in any court, and similar governing body, of competent jurisdiction, including but not limited to equitable relief.
11. **Export Laws.** Insofar as these relate to the activities under this Agreement, Licensee shall comply with all applicable national and international export control laws and regulations. In particular, Licensee shall not directly or indirectly export, re-export, transfer or release any Licensed Materials or direct product thereof to any destination, person, entity or end use restricted or prohibited by applicable laws, without obtaining prior authorization from the applicable competent government authorities to the extent required by those laws.
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ACCEPTED AND AGREED

Licensee ("**Licensee**"): _____

By: _____

Name: _____

Title: _____

Date: _____

Name of Company

Registered office at (full address)

Country